



Corporate & Foundry
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Global Communication Semiconductors, LLC

Process Engineer Backend

Job Req. #0771
Department: Manufacturing Engineering
Status: Full-Time / Salaried
Shift: Monday – Friday (8am – 5pm)
Pay: \$72,000 - \$93,000 annually

Job Description

This position is primarily responsible for the following:

- Process control and development for wafer scribe and break module covering wafer mounting, scribe, break, wafer cleaning, expansion, die pick, and thickness verification
- Operator training
- Documentation upkeep
- Tool ownership of scribe and break tools and assist EQUIP tech on troubleshooting and be contact point for vendors
- Support other backend processes such as incoming inspection, wafer cleaning, defect identification, and other tasks as needed by backend module manager
- Performs other related duties as assigned by management.

Job Requirements

- Bachelor's Degree (BS) from four-year college or university or equivalent combination of education
- Experience with 3 or more years of industrial experience and/or training in wafer scribe and break for GaAs and InP substrates.
- Must have clean room and hands on wafer processing experience
- Strong knowledge in automated optical inspection and wafer scribe/break or sawing process
- Good written and verbal communication skills.
- Computer skills required: Development Software; Microsoft Office; and Eyelit